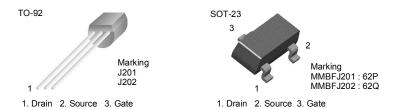


January 2008

J201 - J202 / MMBFJ201 - MMBFJ203 **N-Channel General Purpose Amplifier**

- · This device is designed primarily for low level audio and general purpose applications with high impedance signal sources.
- Sourced from Process 52.



Absolute Maximum Ratings * Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{DG}	Drain-Gate Voltage	40	V
V _{GS}	Gate-Source Voltage	-40	V
I _{GF}	Forward Gate Current	50	mA
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 ~ 150	°C

^{*} These ratings are limiting values above which the serviceability of any semiconductor device may be impaired. NOTES:

Thermal Characteristics* To=25°C unless otherwise noted

Symbol	Parameter	Val	Units	
		J201 - J202	MMBFJ201 - MMBFJ203	Units
P _D	Total Device Dissipation Derate above 25°C	625 5.0	350 2.8	W mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W

^{*} Device mounted on FR-4 PCB 1.6" x 1.6" x 0.06

© 2007 Fairchild Semiconductor Corporation J201 - J202 / MMBFJ201 - MMBFJ203 Rev. 1.0.0 www.fairchildsemi.com

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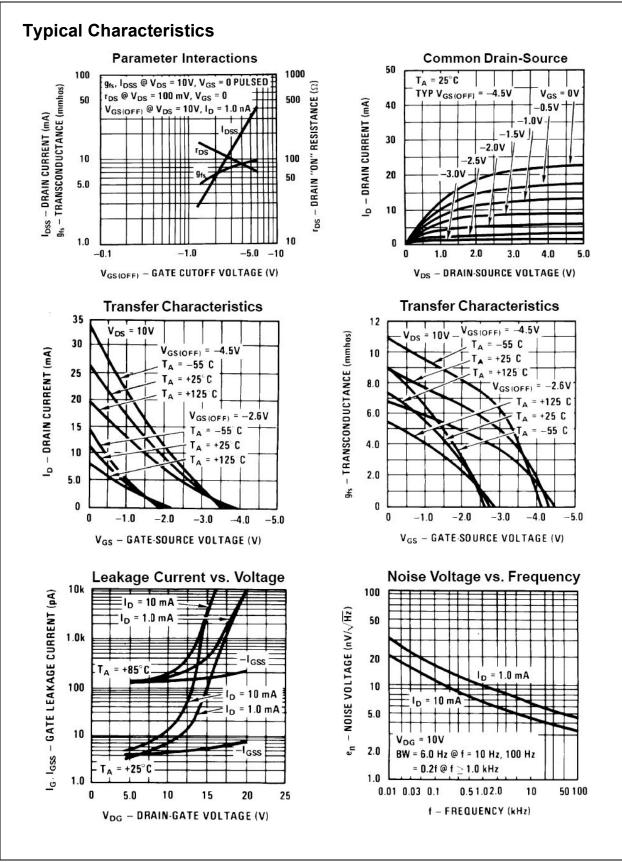
¹⁾ These ratings are based on a maximum junction temperature of 150°C.

2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

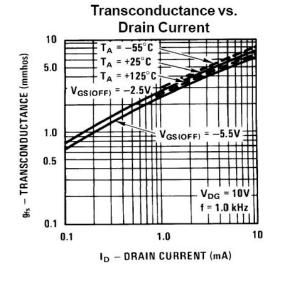
Electrical Characteristics * T_C = 25°C unless otherwise noted

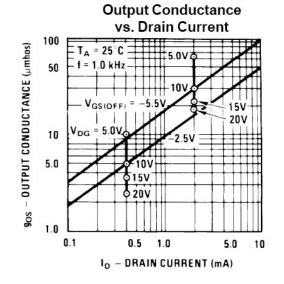
Symbol	Parameter	Conditions		Min.	Max	Units
Off Charact	teristics	<u> </u>				
V _{(BR)GSS}	Gate-Source Breakdwon Voltage	$I_G = -1\mu A, V_{DS} = 0$		-40		V
I _{GSS}	Gate Reverse Current	$V_{GS} = -20V, V_{DS} = 0$			-100	pA
V _{GS} (off)	Gate-Source Cutoff Voltage	V _{DS} = 20V, I _D = 10nA	201 202 203	-0.3 -0.8 -2	-1.5 -4 -10	V
On Charact	teristics				•	•
I _{DSS}	Zero-Gate Voltage Drain Current *	$V_{DS} = 20V, I_{GS} = 0$	201 202 203	0.2 0.9 4	1.0 4.5 20	mA
Small Signa	al Characteristics					
y _{FS}	Forward Transfer Admittance	V _{DS} = 20V, f = 1.0kHz	201 202 203	500 1000 1500		μmhos

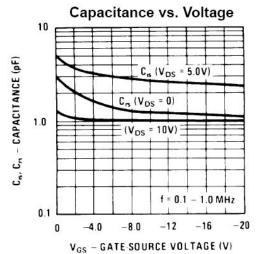
^{*} Pulse Test: Pulse Width \leq 300ms, Duty Cycle \leq 2.0%

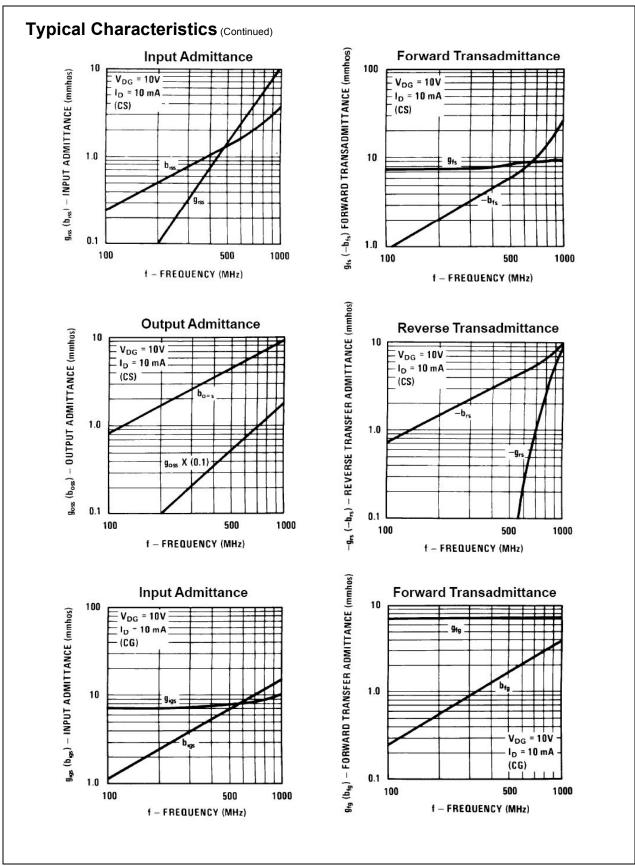


Typical Characteristics (Continued)





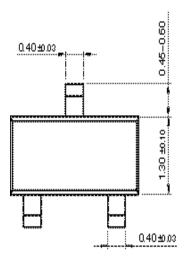


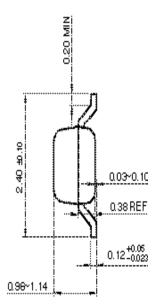


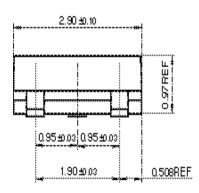
Mechanical Dimensions TO-92 $4.58_{\,-0.15}^{\,+0.25}$ 4.58 ±0.20 0.46±0.10 14.47 50.80 1.27TYP [1.27±0.20] $0.38^{+0.10}_{-0.05}$ 1.27TYP [1.27±0.20] 3.60±020 3.85MAX 0.38 +0.10 102 ±0.10 (R2.29)

Mechanical Dimensions

SOT-23







Dimensions in Millimeters





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